

FEATURES

- Adopt FRED chip
- Low forward Voltage drop
- Fast reverse recovery time
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability

TYPICAL APPLICATIONS

Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MECHANICAL DATA

- **Package:** TO-252
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** As marked

MAXIMUM RATINGS (Ta=25°C Unless otherwise specified)

| PARAMETER | SYMBOL | UNIT | MUR560D |
|---|-----------|------------------|------------|
| Device marking code | | | MUR560D |
| Repetitive Peak Reverse Voltage | V_{RRM} | V | 600 |
| Average Rectified Output Current @60Hz sine wave, R-load, Tc(FIG.1) | I_o | A | 5 |
| Surge(Non-repetitive)Forward Current @60Hz half sine-wave, 1 cycle, Ta=25°C | I_{FSM} | A | 50 |
| Current Squared Time @1ms≤t≤8.3ms Tj=25°C, | I^2t | A ² s | 10 |
| Storage Temperature | T_{stg} | °C | -55 ~ +150 |
| Junction Temperature | T_j | °C | -55 ~ +150 |
| Junction capacitance @4V,1MHz | C_j | pF | 20 |

ELECTRICAL CHARACTERISTICS (Ta=25°C Unless otherwise specified)

| PARAMETER | SYMBOL | UNIT | TEST CONDITIONS | Min | Typ | Max |
|---|------------|------|--|-----|-------|-----|
| Instantaneous forward voltage drop per diode | V_{FM} | V | $I_{FM}=5.0A$ @Tj=25°C | - | 1.45 | 1.6 |
| | | | $I_{FM}=5.0A$ @Tj=150°C | - | 1.15 | 1.3 |
| DC reverse current at rated DC blocking voltage per diode | I_{RRM1} | uA | $V_{RM}=V_{RRM}$ Tj=25°C | - | - | 10 |
| | I_{RRM2} | | $V_{RM}=V_{RRM}$ Tj=150°C | - | 35 | 200 |
| Reverse Recovery Time | T_{RR} | ns | $I_F=0.5A$ $I_{RM}=1A$ $I_{RR}=0.25A$ Tj=25°C | - | 25 | 35 |
| Peak recovery current | I_{RRM} | A | Tj=25°C | - | 3.06 | - |
| | | | Tj=125°C | - | 5.07 | - |
| Reverse recovery charge | Q_{rr} | nC | Tj=25°C | - | 78.88 | - |
| | | | Tj=125°C | - | 280 | - |

■ **THERMAL CHARACTERISTICS** ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

| PARAMETER | | SYMBOL | UNIT | MUR560D |
|--------------------|---------------------------|------------------|----------------------|---------|
| Thermal Resistance | Between junction and case | $R_{\theta J-C}$ | $^{\circ}\text{C/W}$ | 5.0 |
| | Between junction and Air | $R_{\theta J-A}$ | $^{\circ}\text{C/W}$ | 50 |

■ **PACKAGING INFORMATION**

| PREFERRED P/N | UNIT WEIGHT(g) | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|------------------|----------------------|-------------------------|----------------------------|---------------|
| MUR560D | Approximate 0.31 | 2500 | 2500 | 25000 | Reel |

■ **CHARACTERISTICS (TYPICAL)**

FIG1: I_o -Tc Curve

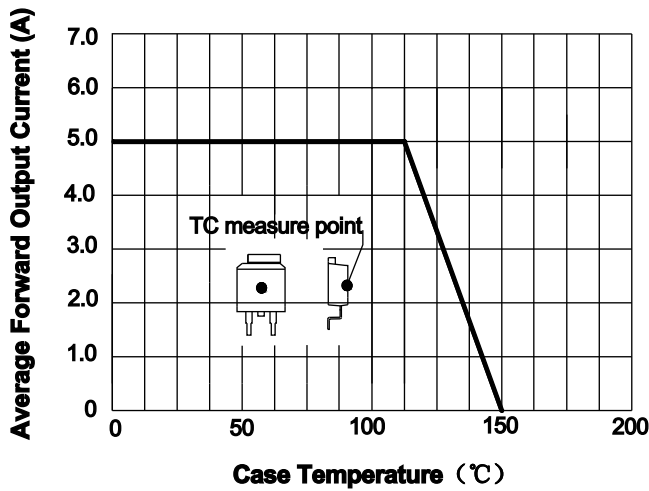


FIG2: Surge Forward Current Capability

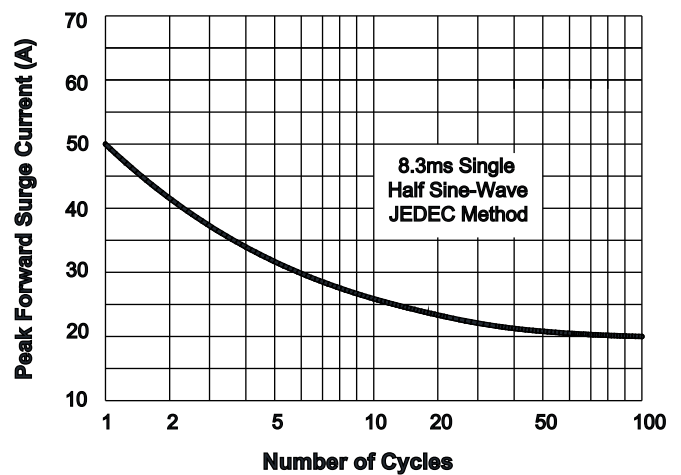


FIG3: Forward Voltage

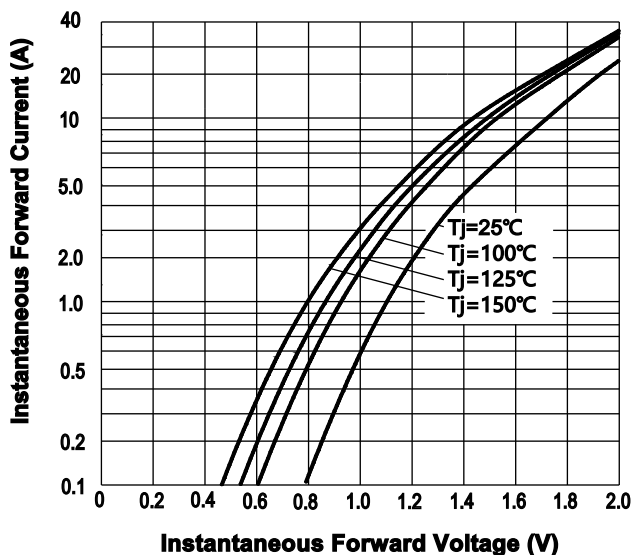


FIG4: Instantaneous Reverse Characteristics

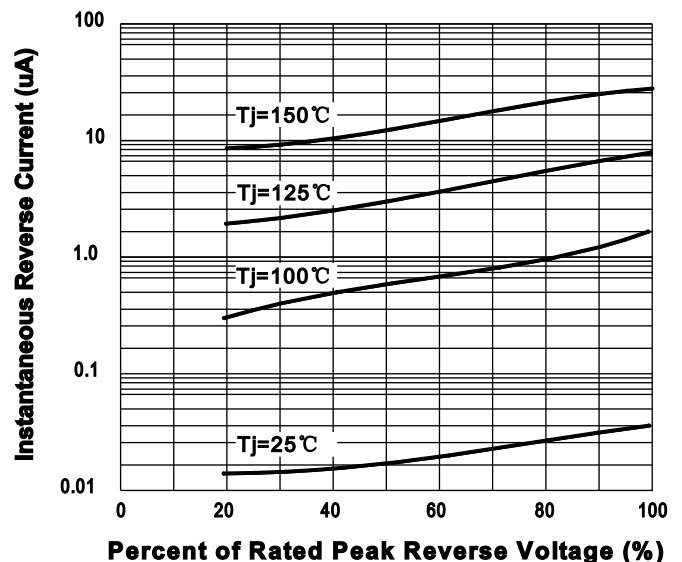
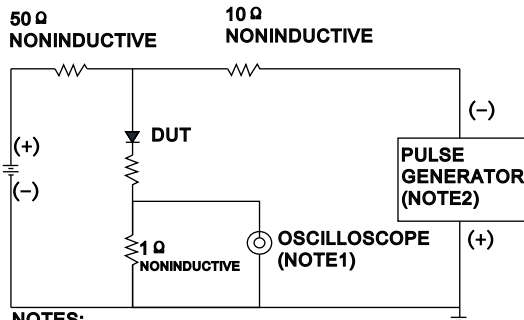
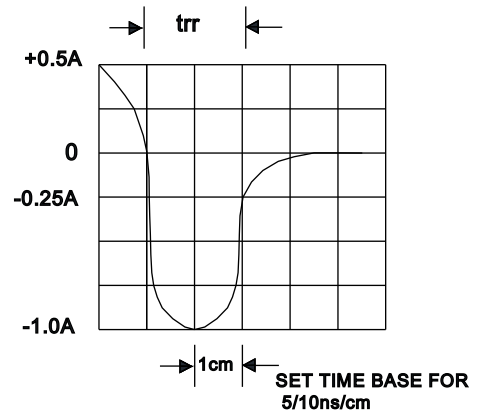


FIG.5: Diagram of circuit and Testing wave form of reverse recovery time



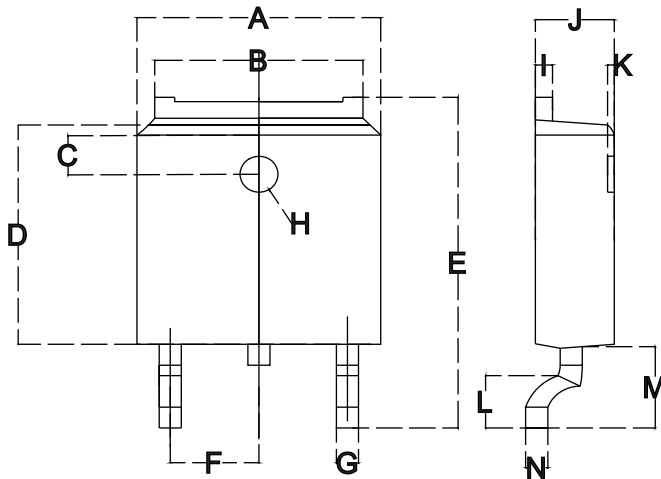
NOTES:
1. Rise Time=7ns max .Input Impedance=1M Ω 22pf
2. Rise Time=10ns max.Source Impedance=50 Ω



■ **OUTLINE DIMENSIONS**

TO-252

单位: mm



| TO-252 | | |
|--------|--------------|--------------|
| Dim | Min | Max |
| A | 6.500 | 6.700 |
| B | 5.100 | 5.460 |
| C | 1.400 | 1.800 |
| D | 6.000 | 6.200 |
| E | 10.000 | 10.400 |
| F | 2.166 | 2.366 |
| G | 0.660 | 0.860 |
| H | Φ 1.050 | Φ 1.350 |
| I | 0.460 | 0.580 |
| J | 2.200 | 2.400 |
| K | 0 | 0.300 |
| L | 0.890 | 2.290 |
| M | 2.730 | 3.080 |
| N | 0.430 | 0.580 |